HCM1A1305

Automotive grade
High current power inductors

Product features

- AEC-Q200 Grade 1 qualified
- High current carrying capacity
- Magnetically shielded, low EMI
- Frequency range up to 1 MHz
- Inductance range from 0.1 µH to 33 µH
- Current range from 3.5 A to 80 A
- 13.8 mm x 12.5 mm footprint surface mount package in a 5.0 mm height
- Moisture Sensitivity Level (MSL): 1
- Alloy powder core material
- Halogen free, lead free, RoHS compliant

Applications

- Body electronics
  - Central body control module
  - Headlamps, tail lamps and interior lighting
  - Heating ventilation and air conditioning controllers (HVAC)
  - Doors, window lift and seat control
- Advanced driver assistance systems
  - Adaptive cruise control (ACC)
  - Automatic parking control
  - Collision avoidance system/ Car black box system
- Infotainment and cluster electronics
  - Audio subsystem: head unit and trunk amp
  - Digital instrument cluster
  - In-vehicle infotainment (IVI) and navigation
- Chassis and safety electronics
  - Airbag control unit
  - Electronic stability control system (ESC)
  - Electric parking brake
  - Electronic Power Steering (EPS)
- Engine and Powertrain Systems
  - Electric pumps, motor control and auxiliaries
  - Powertrain control module (PCU)/Engine Control unit (ECU)
  - Transmission Control Unit (TCU)

Environmental Data

- Storage temperature range (Component): -55 °C to +155 °C
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant

Pb HALOGEN HF FREE RoHS

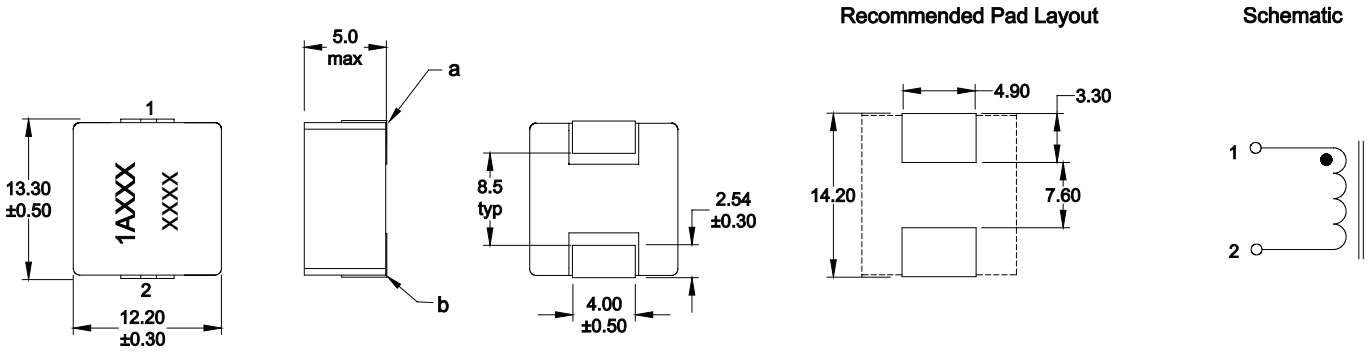
Powering Business Worldwide

Product Specifications

Part Number[6]	OCL[1] (µH) ± 20%	FLL[2] (µH) minimum	I_{rms}[3] (A)	I_{sat}[4] (A)	DCR (mΩ) typical @ +20°C	DCR (mΩ) maximum @ +20°C	K-factor[5]
HCM1A1305-R10-R	0.10	0.064	43	80	0.52	0.59	818
HCM1A1305-R22-R	0.22	0.14	40	44	0.63	0.72	458
HCM1A1305-R33-R	0.33	0.21	35	44	0.80	0.92	379
HCM1A1305-R47-R	0.47	0.30	33	36	0.80	0.92	375
HCM1A1305-R56-R	0.56	0.36	28	36	1.15	1.33	265
HCM1A1305-R68-R	0.68	0.44	27	32	1.15	1.33	263
HCM1A1305-R82-R	0.82	0.52	26	26	1.4	1.61	262
HCM1A1305-1R0-R	1.0	0.64	22	30	2.1	2.42	214
HCM1A1305-1R5-R	1.5	0.96	18	22	2.75	3.16	177
HCM1A1305-1R8-R	1.8	1.15	16	20	4.0	4.6	154
HCM1A1305-2R2-R	2.2	1.41	15	18	4.6	5.29	153
HCM1A1305-3R3-R	3.3	2.11	12	16	7.7	9.2	134
HCM1A1305-4R7-R	4.7	3.01	9.3	15	11	12.7	102
HCM1A1305-5R6-R	5.6	3.58	8.8	15	12	13.8	89
HCM1A1305-6R0-R	6.0	3.84	8.1	12.5	12.5	14.5	90
HCM1A1305-6R8-R	6.8	4.35	8.3	13	13	15	74
HCM1A1305-7R8-R	7.8	4.99	7.6	15	16.8	19.4	70
HCM1A1305-8R2-R	8.2	5.25	7.3	13	17.5	20.1	67
HCM1A1305-100-R	10	6.40	6.8	13	19	21.9	65
HCM1A1305-120-R	12	7.68	5.5	9.0	21	24	81
HCM1A1305-150-R	15	9.6	5.8	11	29	33.4	49
HCM1A1305-220-R	22	14.1	3.5	6.8	45	51.8	43
HCM1A1305-330-R	33	21.1	4.0	7.0	74.5	85.5	32

1. Open Circuit Inductance (OCL) Test Parameters: 100 kHz, 0.25 V_{rms}, 0.0 Adc, +25 °C
2. Full Load Inductance (FLL) Test Parameters: 100 kHz, 0.25 V_{rms}, I_{sat}, +25 °C
3. I_{rms}: DC current for an approximate temperature rise of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 155 °C under worst case operating conditions verified in the end application.
4. I_{sat}: Peak current for approximately 20% rolloff @ +25 °C
5. K-factor: Used to determine B_{p-p} for core loss (see graph). Bp-p = K * L * ΔI. B_{p-p}: (Gauss), K: (K-factor from table), L: (Inductance in µH), ΔI (Peak to peak ripple current in Amps).
6. Part Number Definition: HCM1A1305-xxx-R
   HCM1A1305 = Product code and size
   xxx= inductance value in µH, R= decimal point,
   If no R is present then last character equals number of zeros
   -R suffix = RoHS compliant

Dimensions (mm)

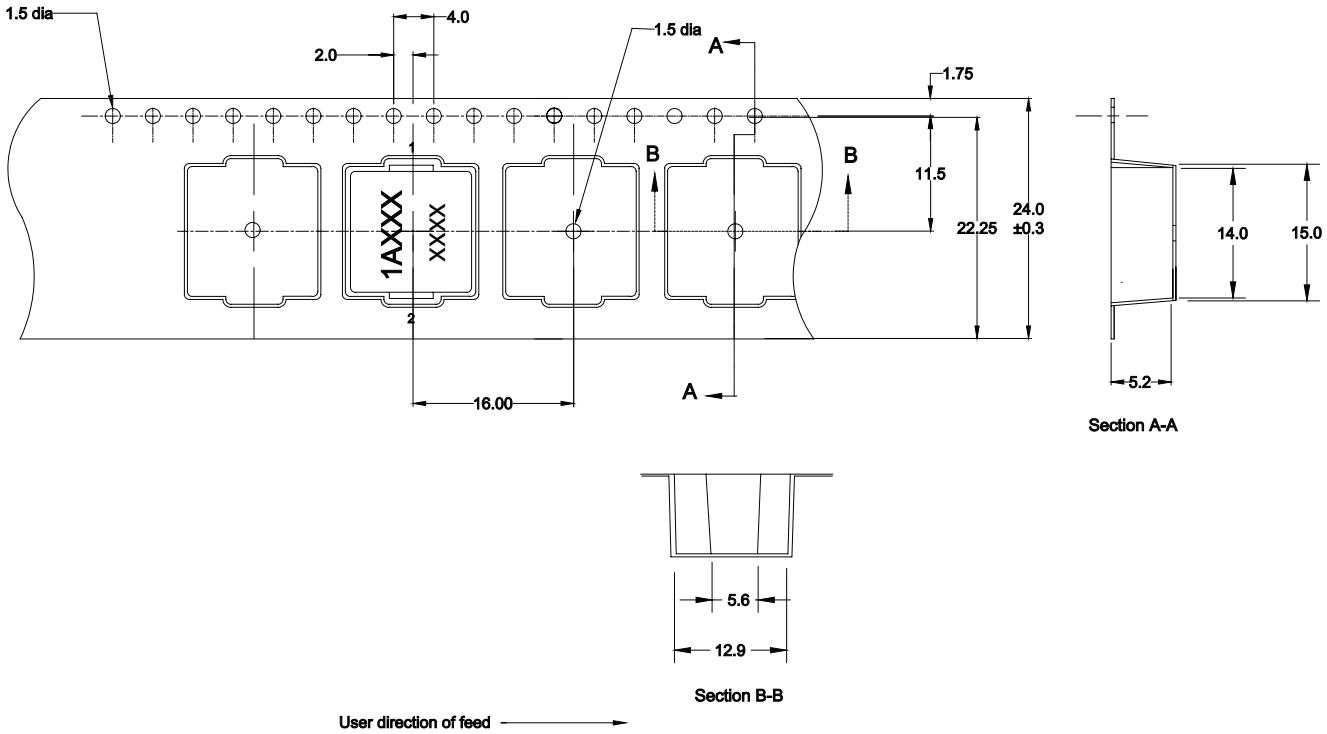


Part marking: 1AXXX=automotive grade, XXX=inductance value in uH, R=decimal point. If no R is present then last character equals number of zeros. xxxx=Lot code
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ±0.3 millimeters unless stated otherwise
DCR measured from point "a" to point "b"
Color: Grey
Do not route traces or vias underneath the inductor

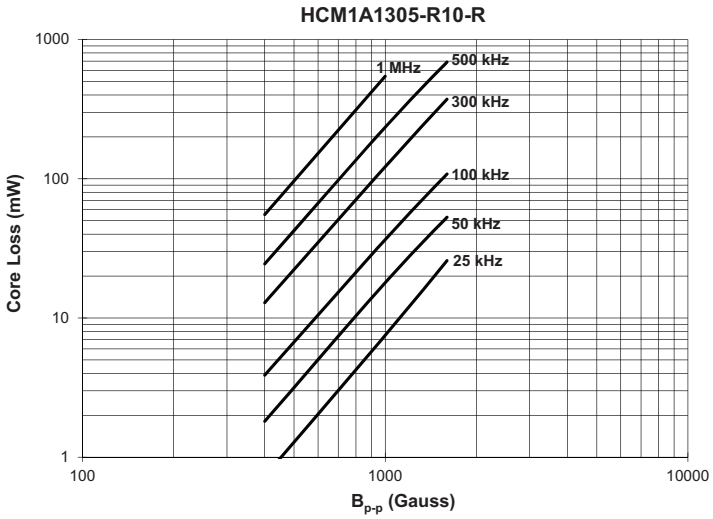
Packaging information (mm)

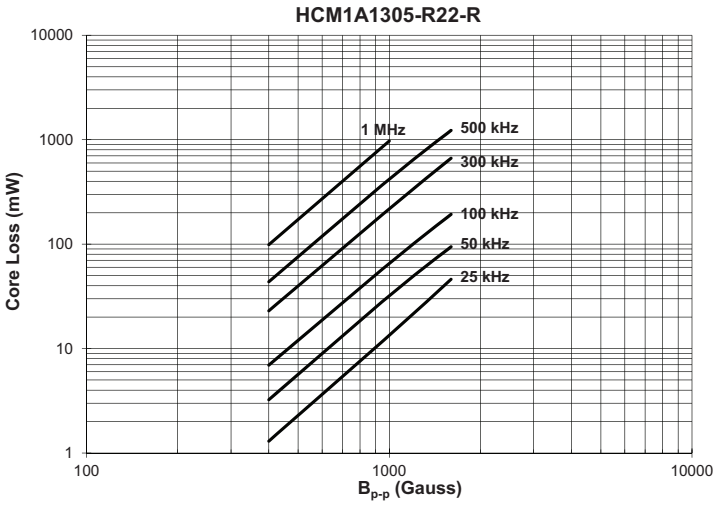
Drawing not to scale

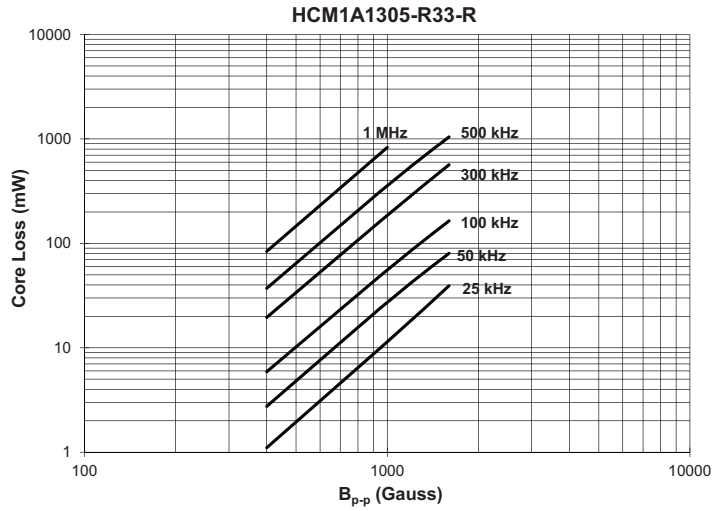
Supplied in tape and reel packaging, 250 parts per 13" diameter reel

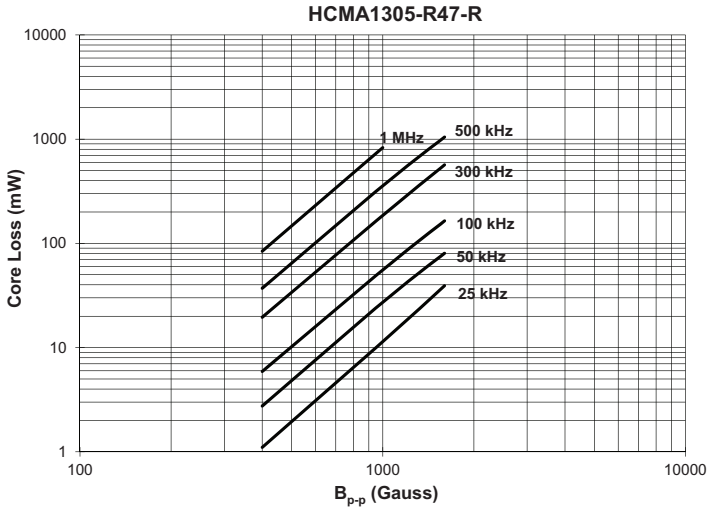


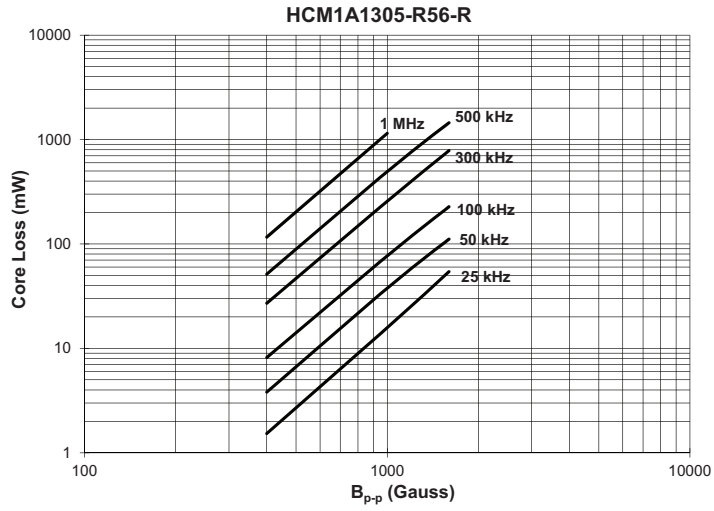
Core loss vs B_{p-p}

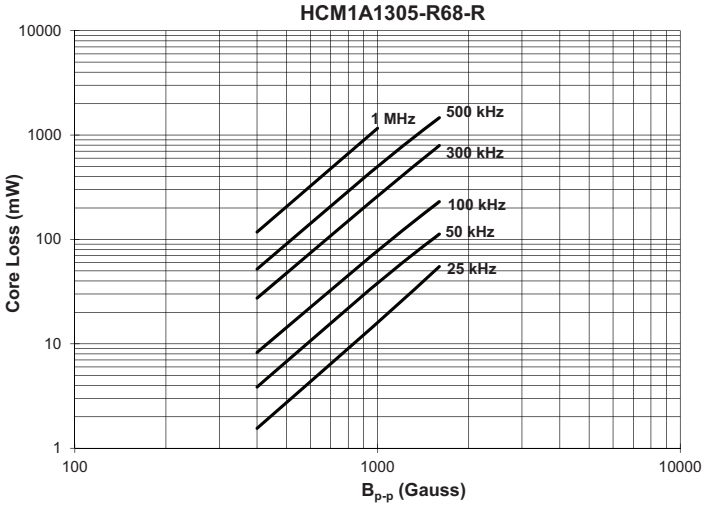






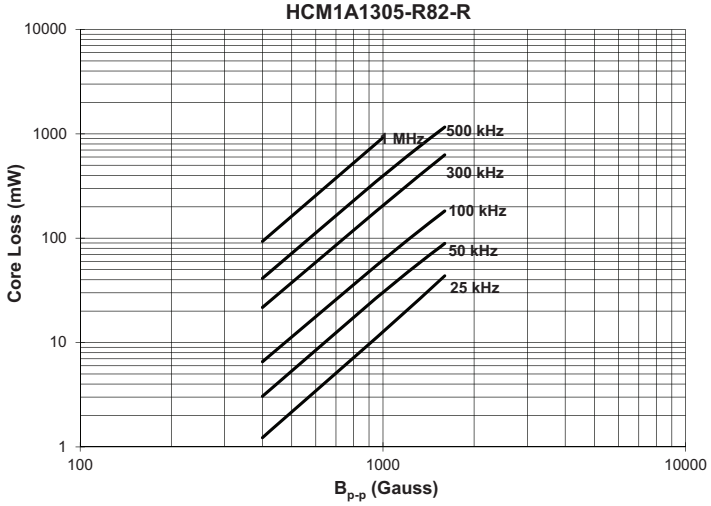






Core loss vs B_{p-p}

HCM1A1305-R82-R



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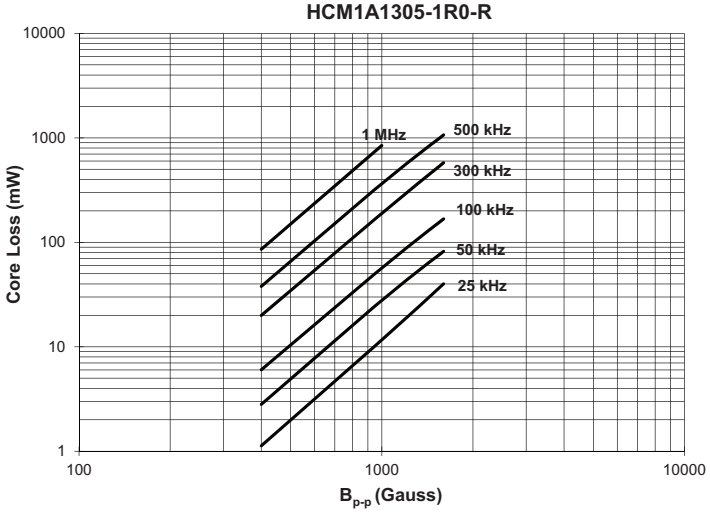

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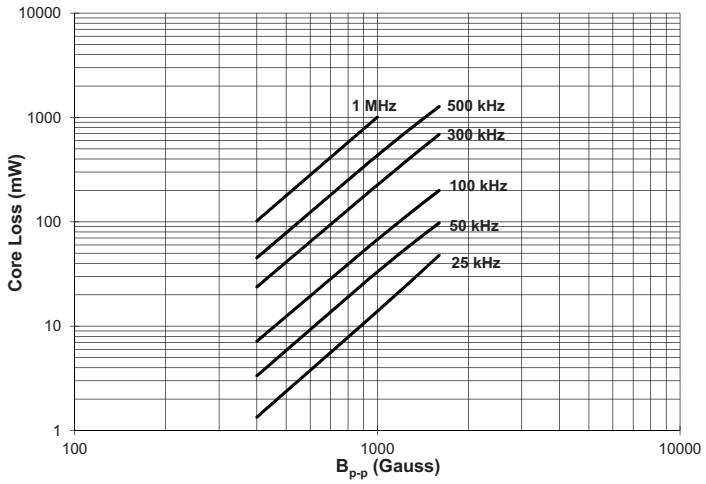

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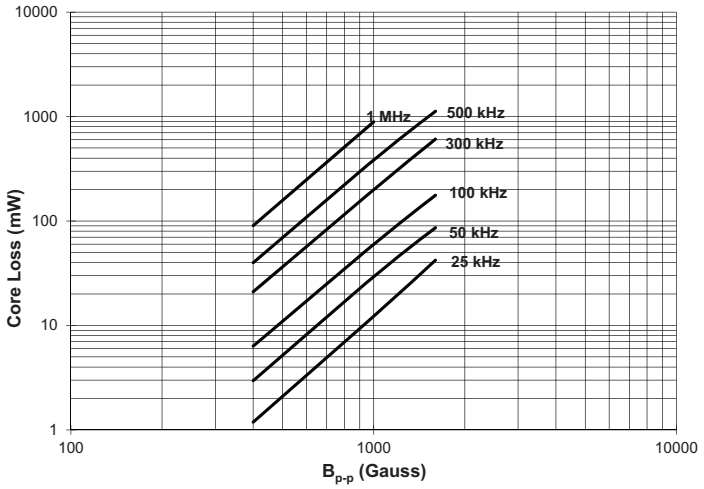

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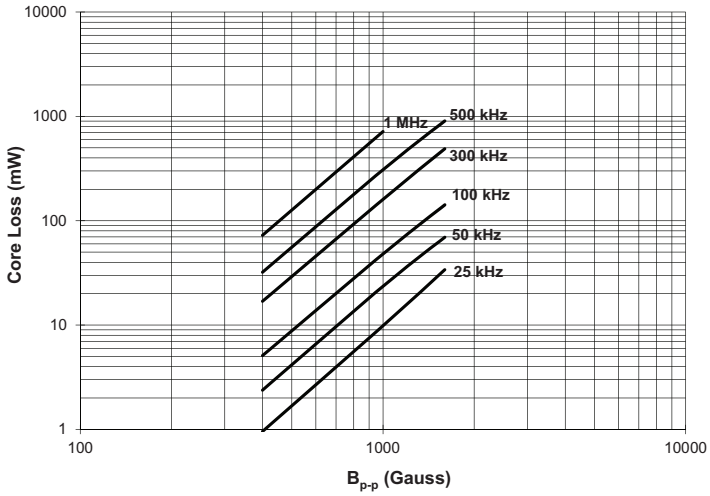

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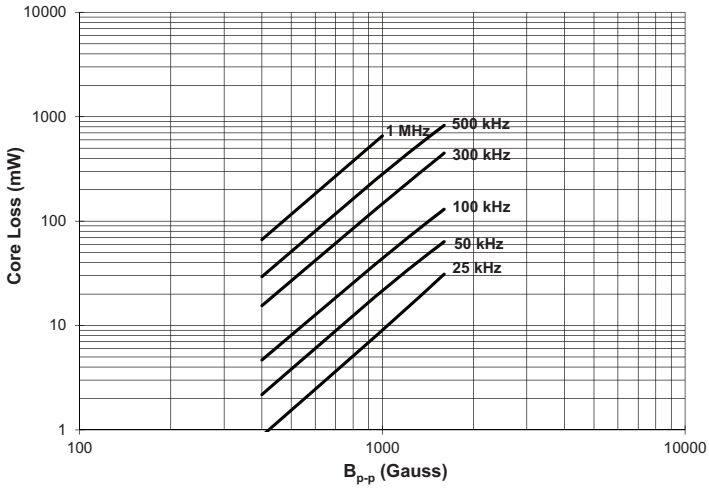

Core loss vs B_{p-p}

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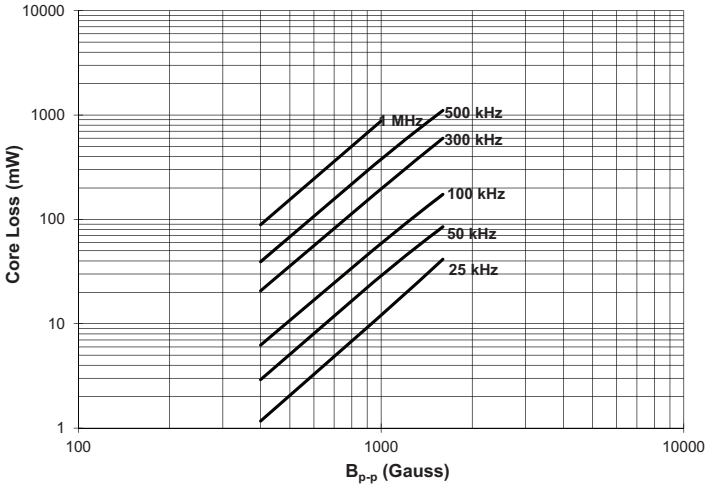

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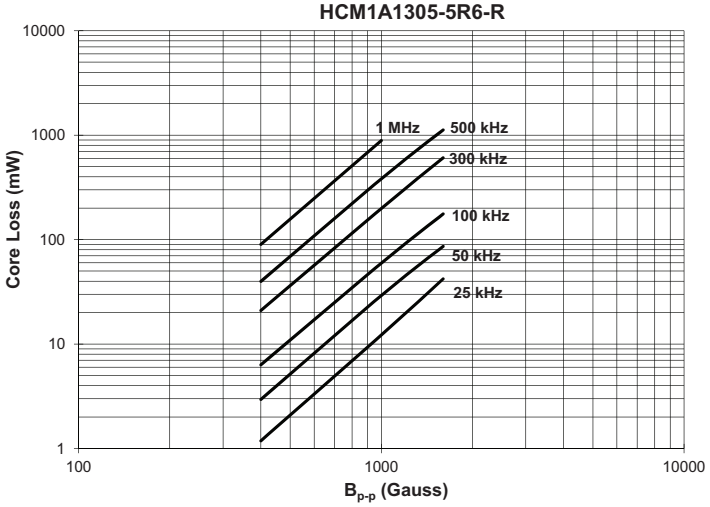

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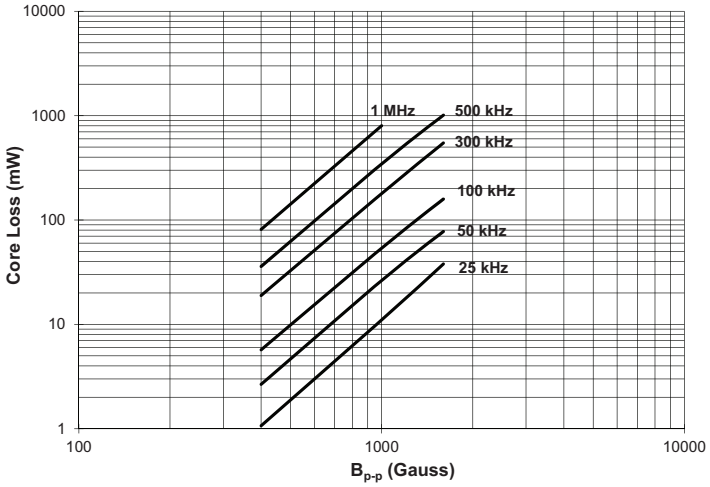

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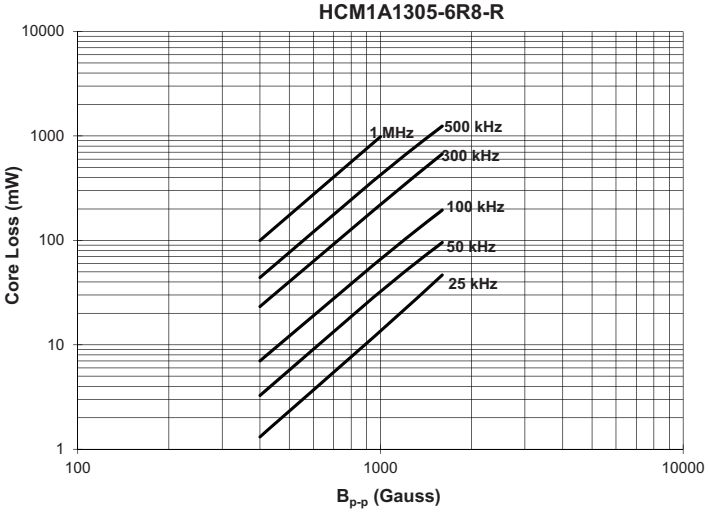

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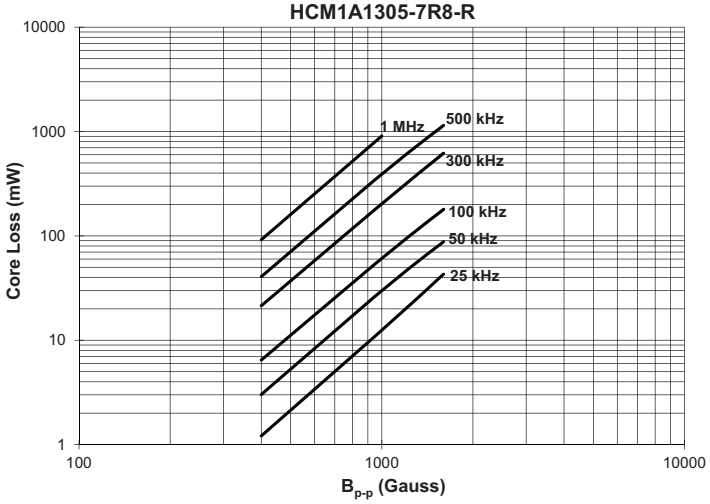

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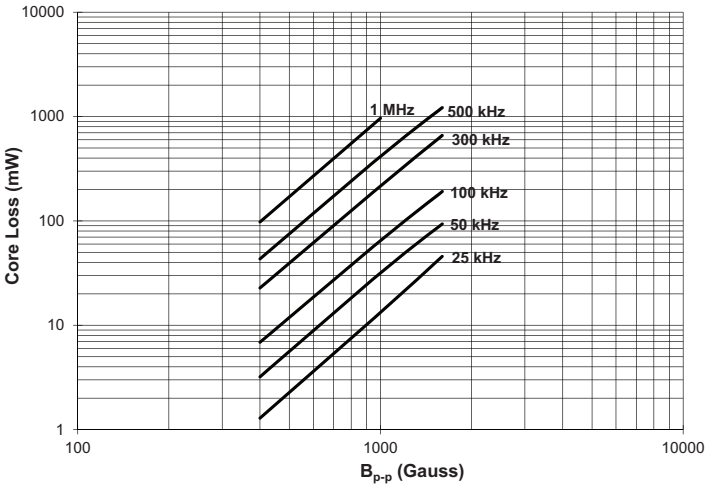
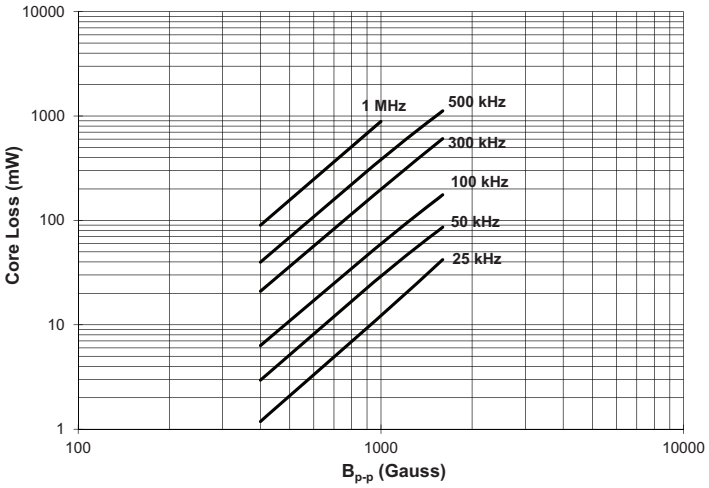


Core loss vs B_{p-p}

HCM1A1305-100-R



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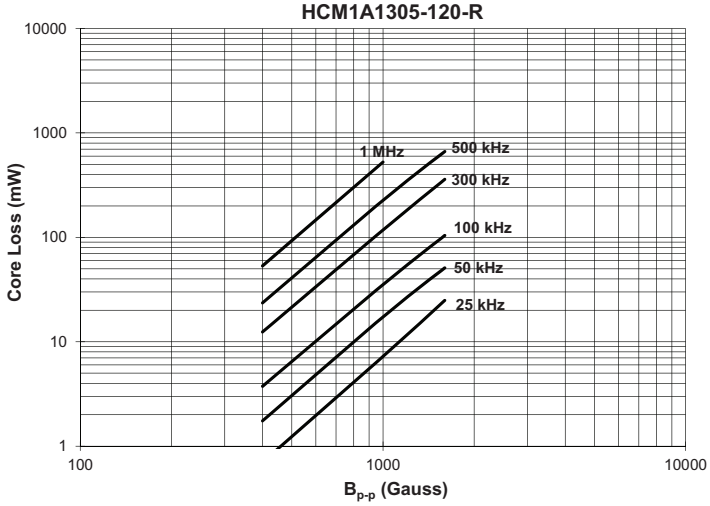

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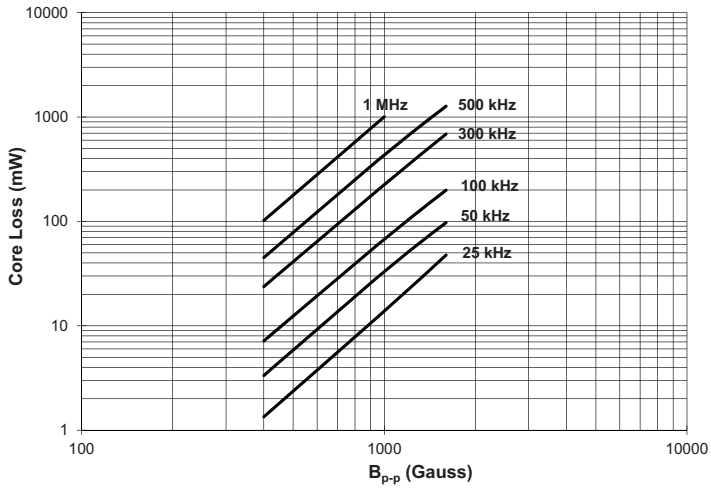

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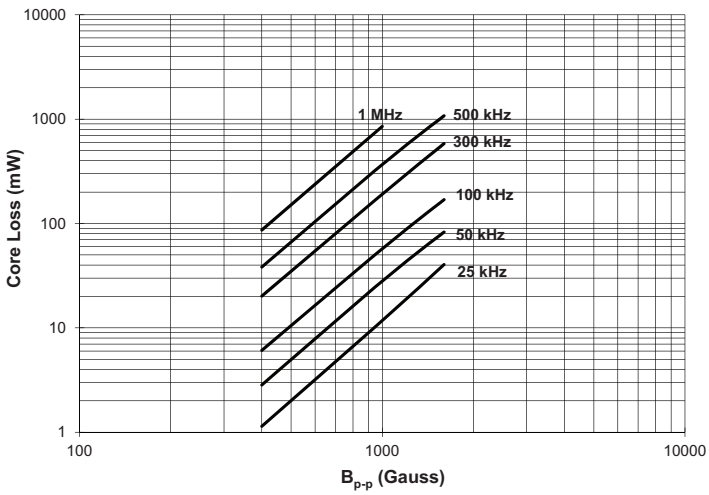

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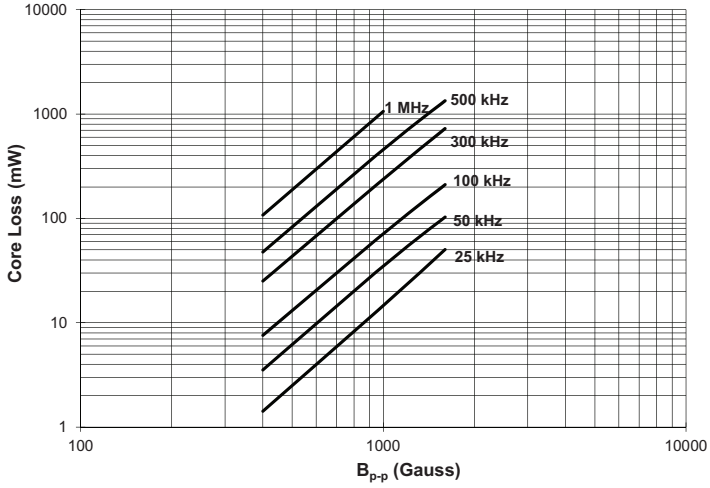
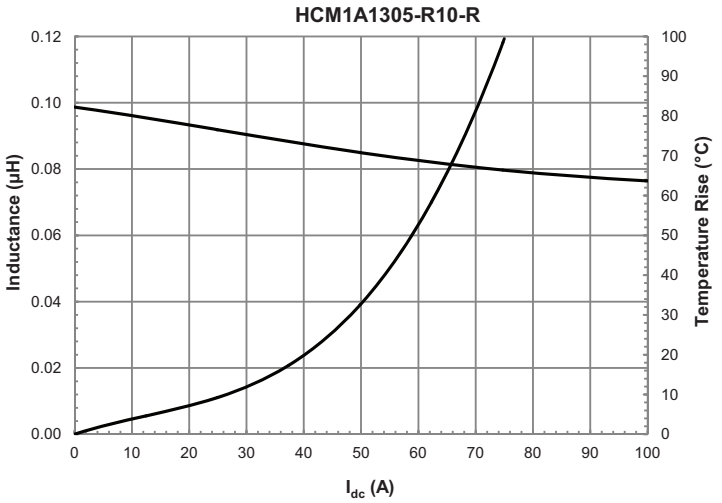
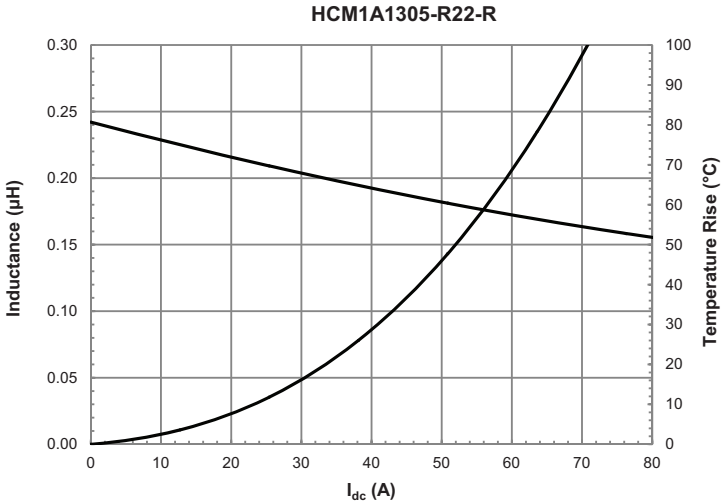
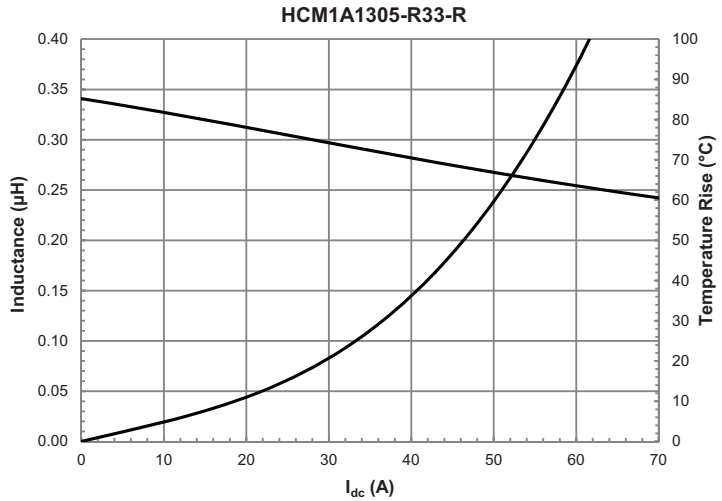
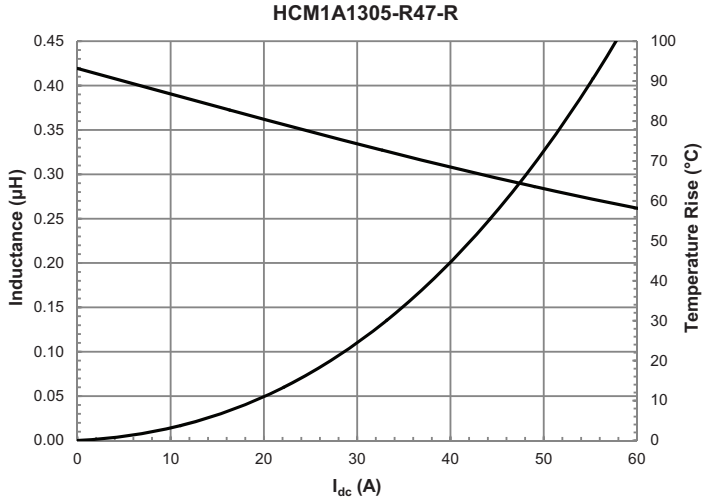


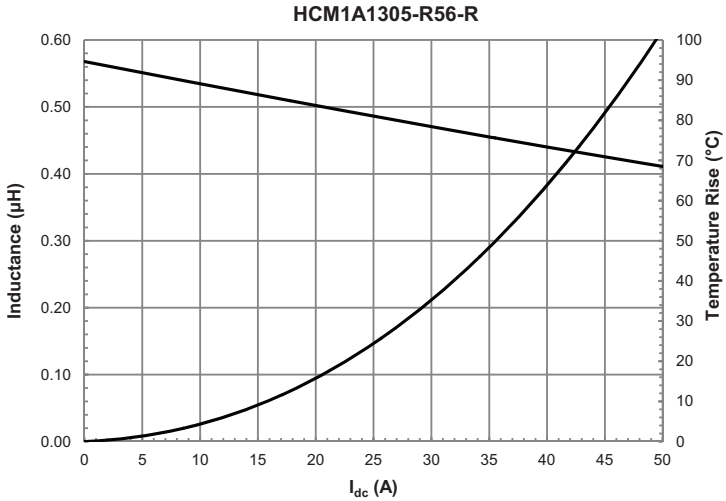
Inductance and temperature rise vs. current

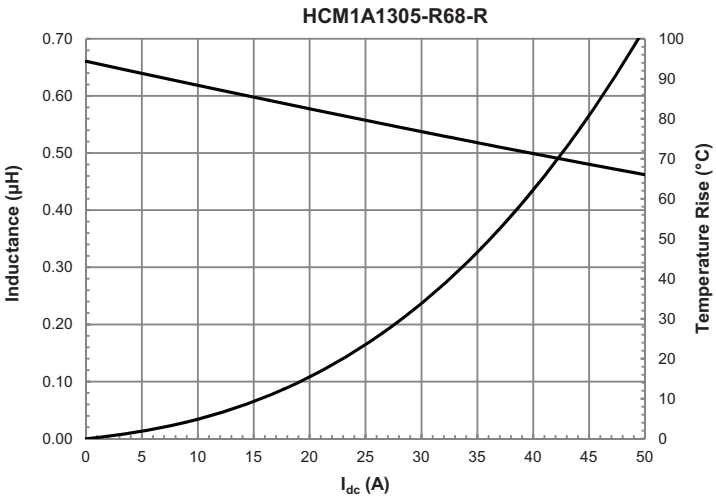




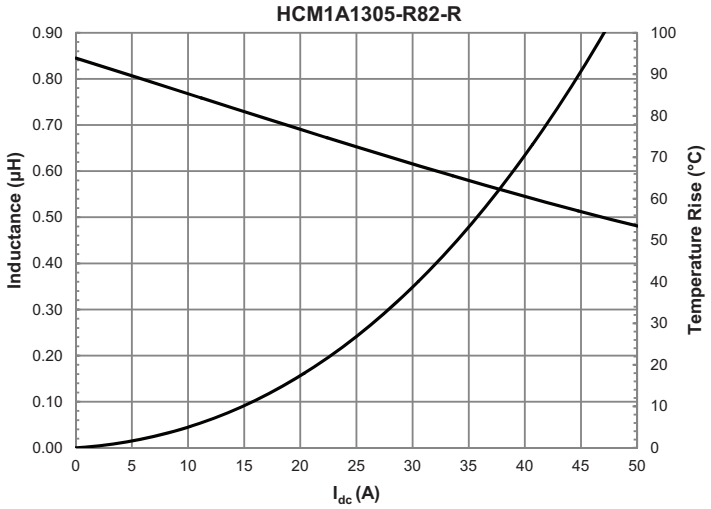


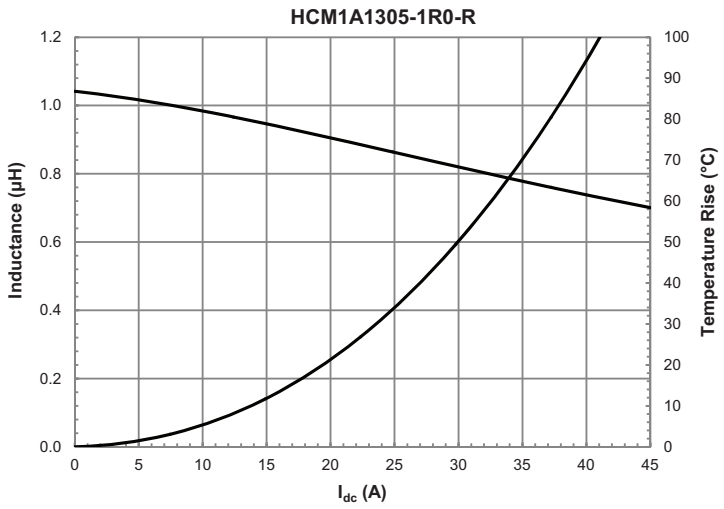


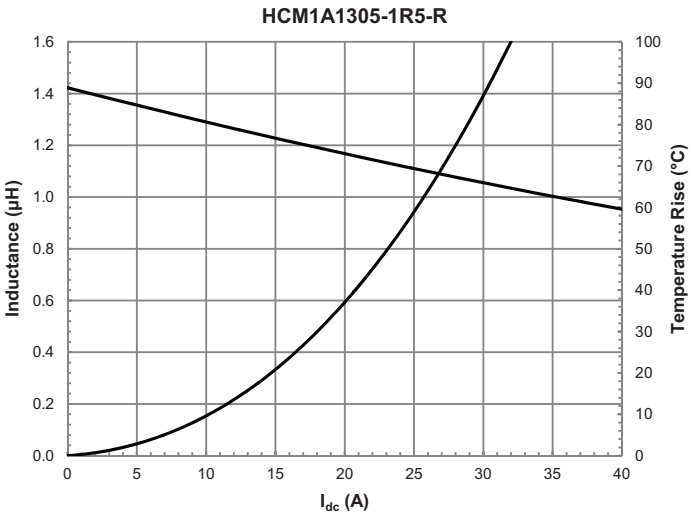


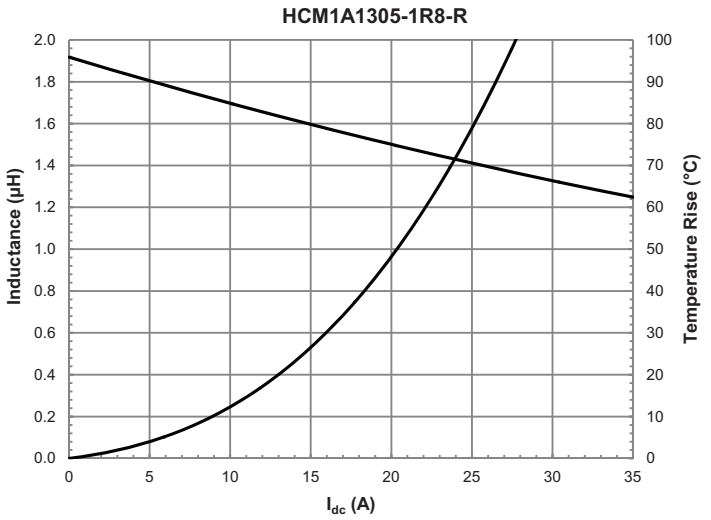


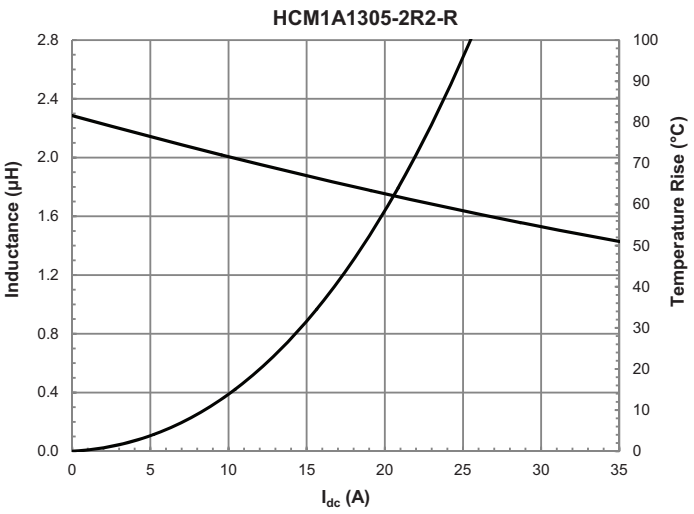
Inductance and temperature rise vs. current

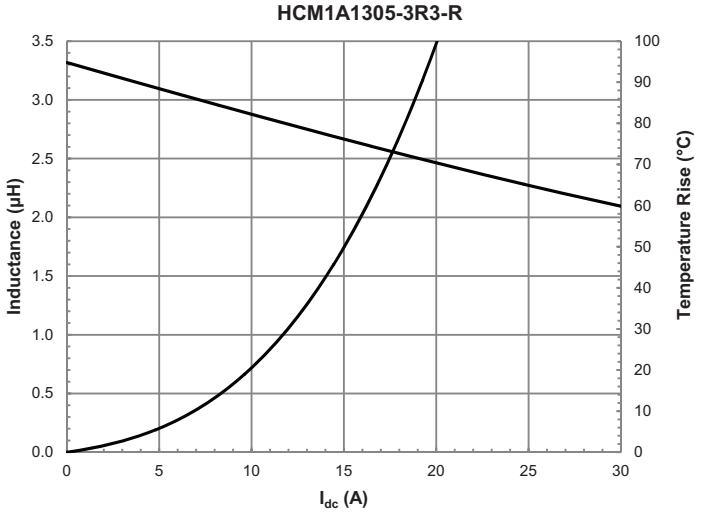






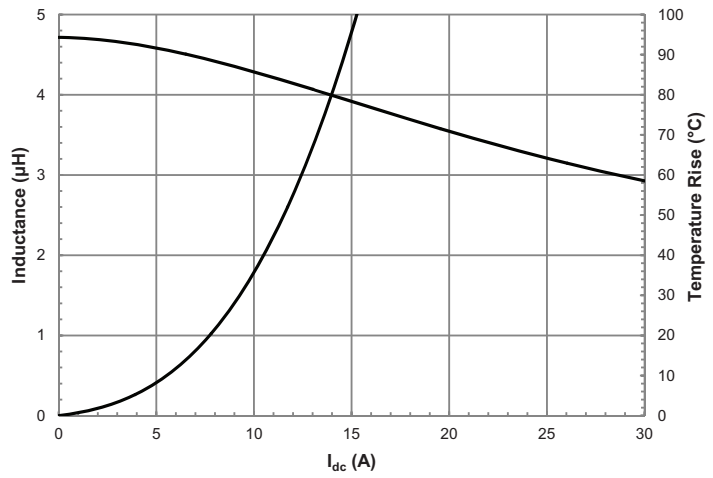




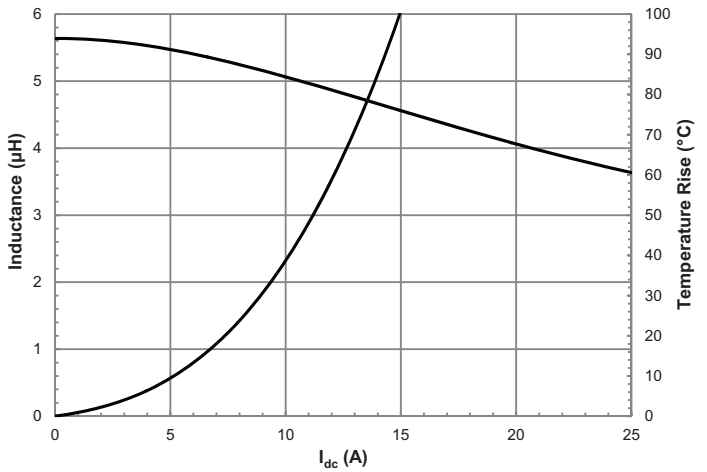


Inductance and temperature rise vs. current

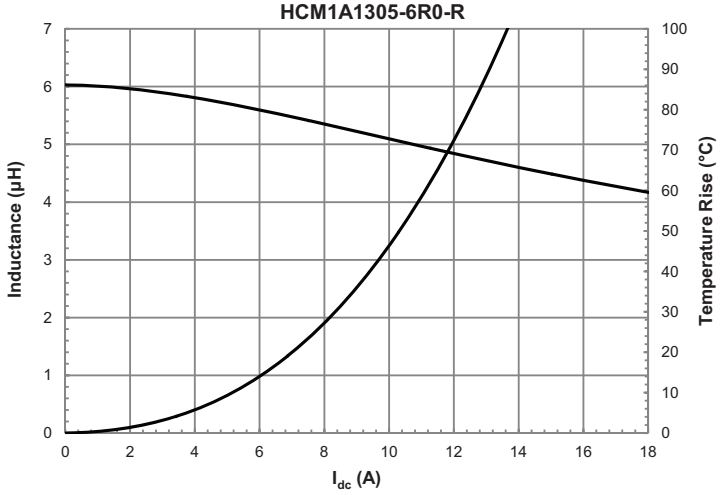
HCM1A1305-4R7-R



HCM1A1305-5R6-R



HCM1A1305-6R0-R



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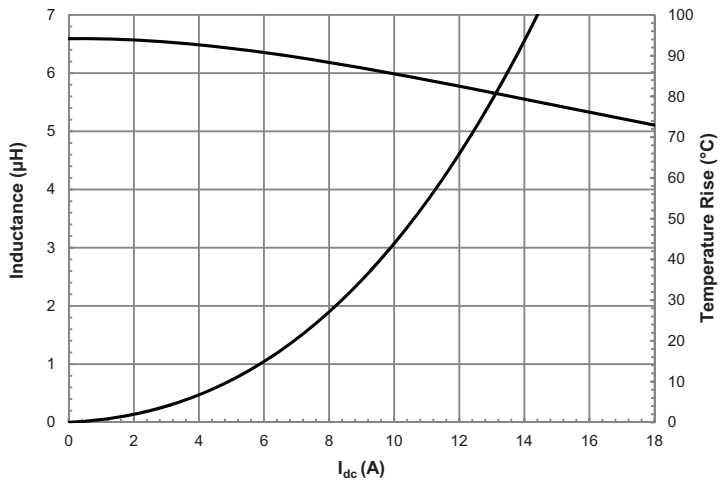
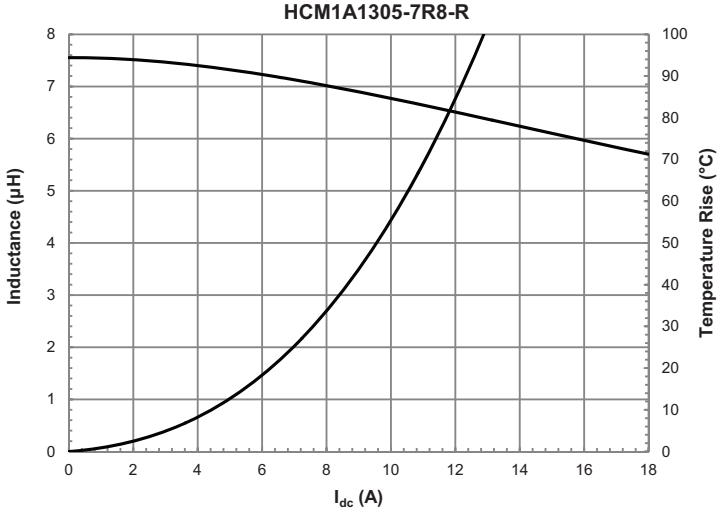


HCM1A1305-7R8-R



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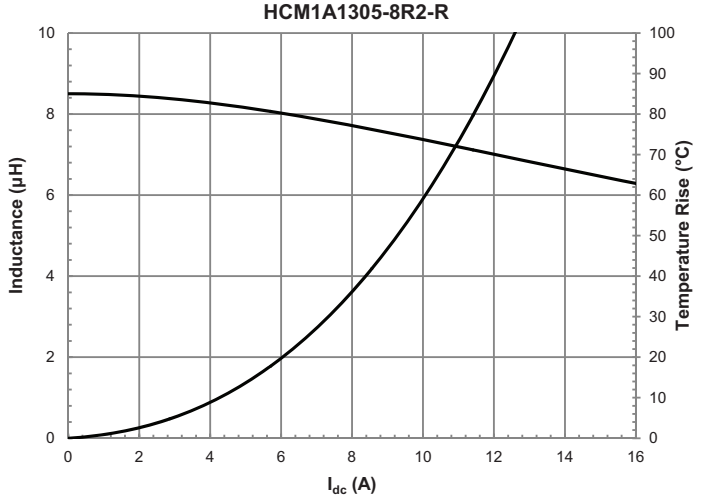
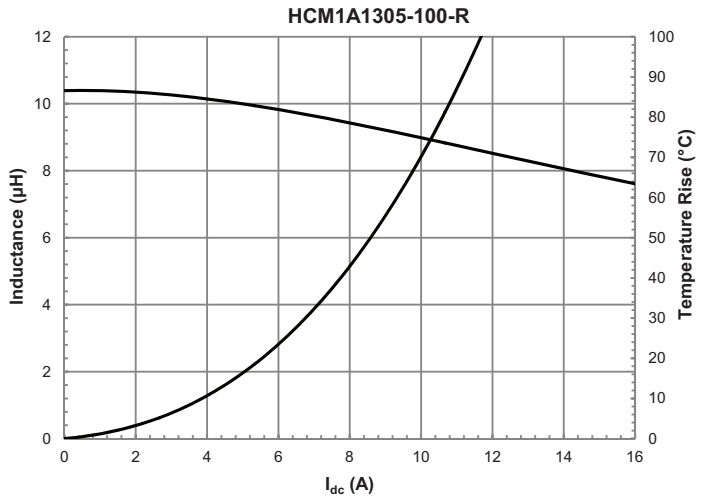
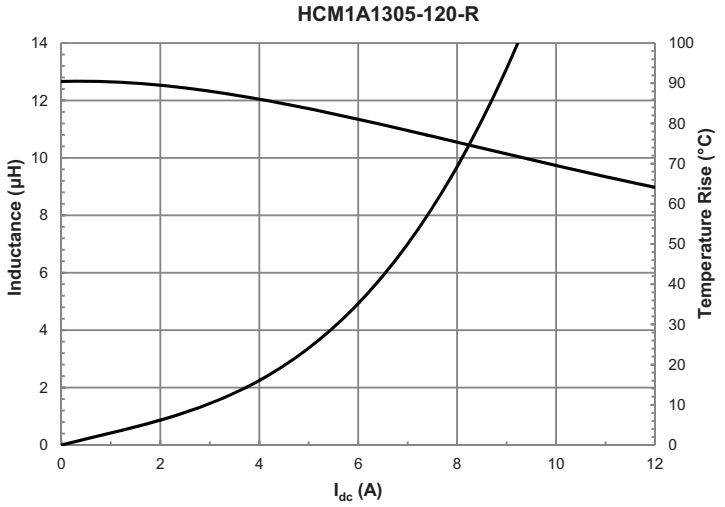
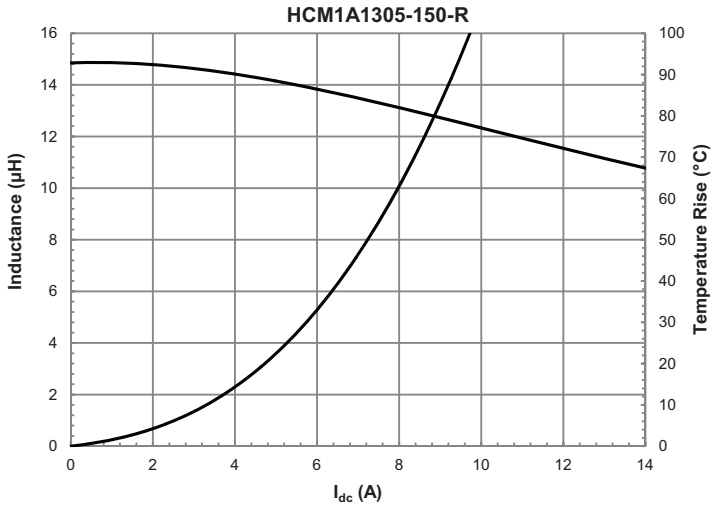
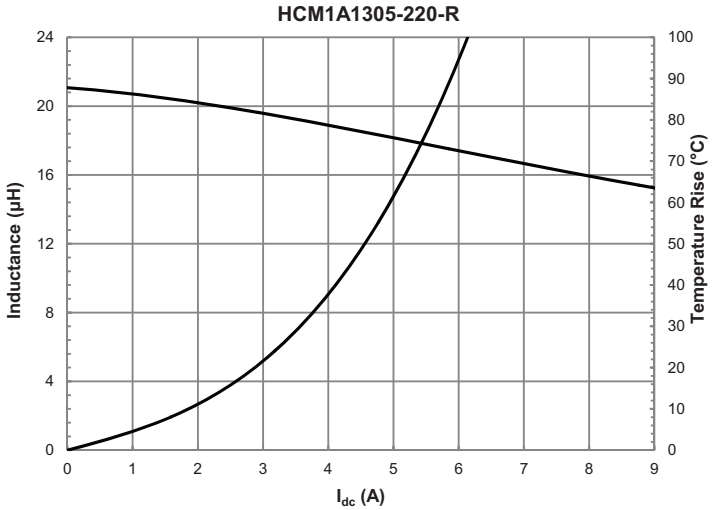


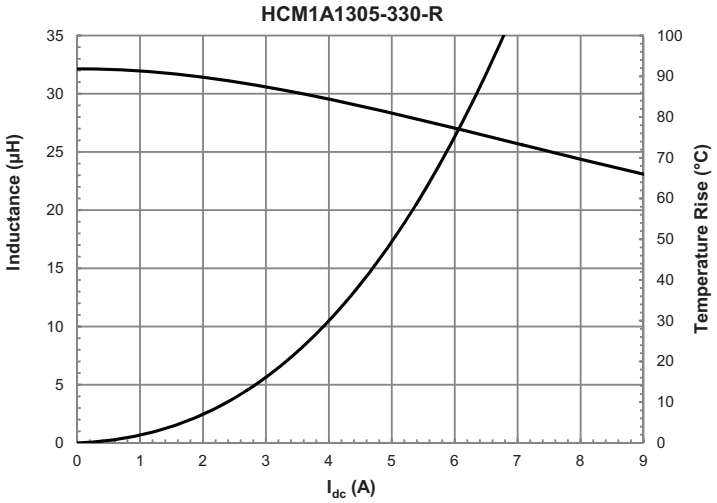
Inductance and temperature rise vs. current











Solder reflow profile

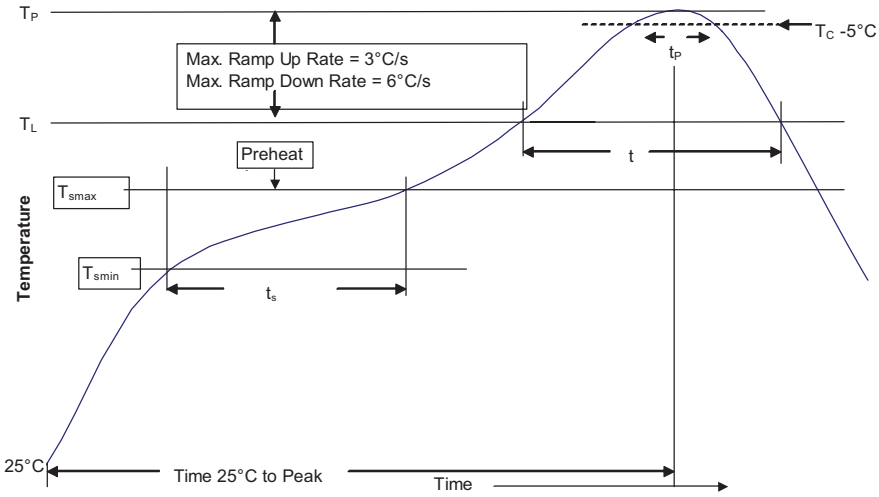


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm^3 <350	Volume mm^3 350 - 2000	Volume mm^3 >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	• Temperature min. (T_{smin})	100°C	150°C
	• Temperature max. (T_{smax})	150°C	200°C
	• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_p		3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L) Time at liquidous (t_L)		183°C 60-150 Seconds	217°C 60-150 Seconds
Peak package body temperature (T_P)*		Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)		20 Seconds**	30 Seconds**
Average ramp-down rate (T_p to T_{smax})		6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

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Powering Business Worldwide

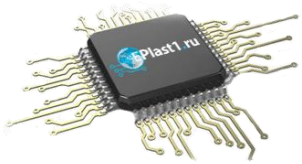
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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